

SSC8645GN6

N and P-Channel Enhancement Mode Power MOSFET

➤ Features

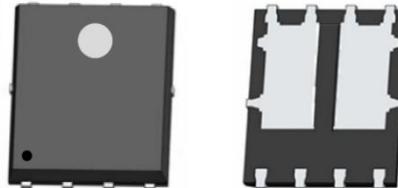
N-Channel

| V _{DS} | V _{GS} | R _{DSON} Typ. | I _D |
|-----------------|-----------------|-------------------------|----------------|
| 40V | ±20V | 9.5mΩ@10V 12.5mΩ@4V5 | 47A |
| | | | |

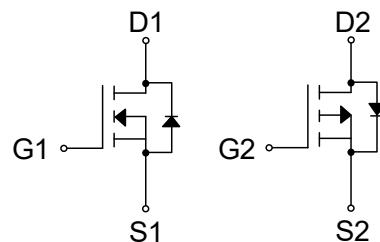
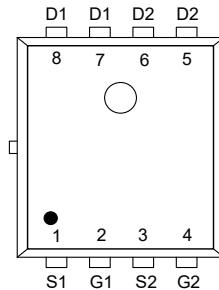
P-Channel

| V _{DS} | V _{GS} | R _{DSON} Typ. | I _D |
|-----------------|-----------------|----------------------------|----------------|
| -40V | ±20V | 11.5mΩ@-10V 16.5mΩ@-4V5 | -43A |
| | | | |

➤ Pin configuration



PDFN5X6-8L



Pin Configuration (Top View)



Marking

(XXYY: Internal Traceability Code)

➤ Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | N-Channel | P-Channel | Unit |
|-----------|---|-------------------------|-----------|------------------|
| V_{DSS} | Drain-to-Source Voltage | 40 | -40 | V |
| V_{GSS} | Gate-to-Source Voltage | ± 20 | ± 20 | V |
| I_D | Continuous Drain Current ^d | $T_C=25^\circ\text{C}$ | 47 | A |
| | | $T_C=100^\circ\text{C}$ | 26 | |
| I_{DSM} | Continuous Drain Current ^a | $T_A=25^\circ\text{C}$ | 14 | A |
| | | $T_A=70^\circ\text{C}$ | 10.5 | |
| I_{DM} | Pulsed Drain Current ^b | 188 | -172 | A |
| P_D | Power Dissipation ^c | $T_C=25^\circ\text{C}$ | 34 | W |
| | | $T_C=100^\circ\text{C}$ | 13.5 | |
| P_{DSM} | Power Dissipation ^a | $T_A=25^\circ\text{C}$ | 3 | W |
| | | $T_A=70^\circ\text{C}$ | 1.9 | |
| I_{AS} | Avalanche Current ^b L=0.5mH Single Pulse | 17 | -28 | A |
| E_{AS} | Avalanche Energy ^b L=0.5mH Single Pulse | 72 | 196 | mJ |
| T_J | Operation junction temperature | -55~150 | | $^\circ\text{C}$ |
| T_{STG} | Storage temperature range | -55~150 | | |

➤ Thermal Resistance Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Ratings | Max. | Unit |
|-----------------|---|---------|------|---------------------------|
| $R_{\theta JA}$ | Junction-to-Ambient Thermal Resistance ^a | 41 | 53 | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JC}$ | Junction-to-Case Thermal Resistance | 3.7 | 4.8 | |

Note:

- The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz.copper,in a still air environment with $T_A=25^\circ\text{C}$.The value in any given application depends on the user specific board design. The current rating is based on the $t \leq 10\text{s}$ thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The power dissipation P_D is based on $T_{J(MAX)}=150^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.

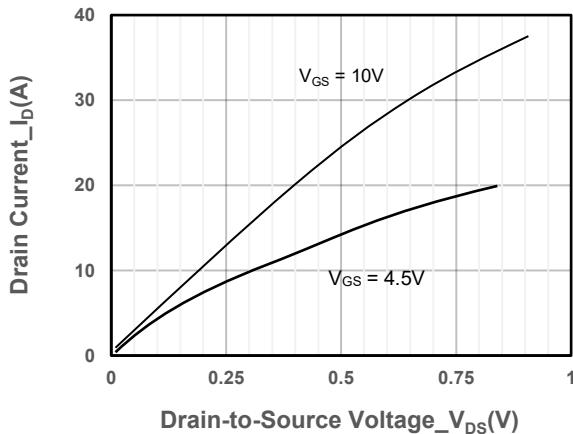
➤ N-Channel Electrical Characteristics ($T_A=25^\circ C$ unless otherwise noted)

| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------------------------|---------------|--|------|------|-----------|-----------|
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 250\mu A$ | 40 | | | V |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\mu A$ | 1.2 | | 2.2 | V |
| Drain-Source On-Resistance | $R_{DS(on)}$ | $V_{GS} = 10V, I_D = 20A$ | | 9.5 | 14 | $m\Omega$ |
| Drain-Source On-Resistance | $R_{DS(on)}$ | $V_{GS} = 4.5V, I_D = 10A$ | | 12.5 | 18 | $m\Omega$ |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 40V, V_{GS} = 0V$ | | | 1 | μA |
| Gate-Source Leak Current | I_{GSS} | $V_{GS} = \pm 20V, V_{DS} = 0V$ | | | ± 100 | nA |
| Forward Voltage | V_{SD} | $V_{GS} = 0V, I_S = 5A$ | | | 1.2 | V |
| Gate Resistance | R_G | $V_{DS} = 0V, f = 1MHz$ | | 2.7 | | Ω |
| Input Capacitance | C_{iss} | $V_{DS} = 20V, V_{GS} = 0V,$ $f = 1MHz$ | | 1168 | | pF |
| Output Capacitance | C_{oss} | | | 80 | | |
| Reverse Transfer Capacitance | C_{rss} | | | 76 | | |
| Total Gate Charge | Q_G | $V_{GS} = 10V, V_{DS} = 25V,$ $I_D = 5A$ | | 16 | | nC |
| Gate to Source Charge | Q_{GS} | | | 8.5 | | |
| Gate to Drain Charge | Q_{GD} | | | 10 | | |
| Turn-on Delay Time | $T_{D(ON)}$ | $V_{GS} = 10V, V_{DS} = 25V,$ $R_L = 0.75\Omega, R_{GEN} = 6\Omega$ | | 6.5 | | ns |
| Rise Time | T_r | | | 13 | | |
| Turn-off Delay Time | $T_{D(OFF)}$ | | | 8 | | |
| Fall Time | T_f | | | 7 | | |
| Diode Recovery Time | T_{rr} | $I_F=5A, di/dt=100A/us$ | | 53 | | ns |
| Diode Recovery Charge | Q_{rr} | $I_F=5A, di/dt=100A/us$ | | 39 | | nC |

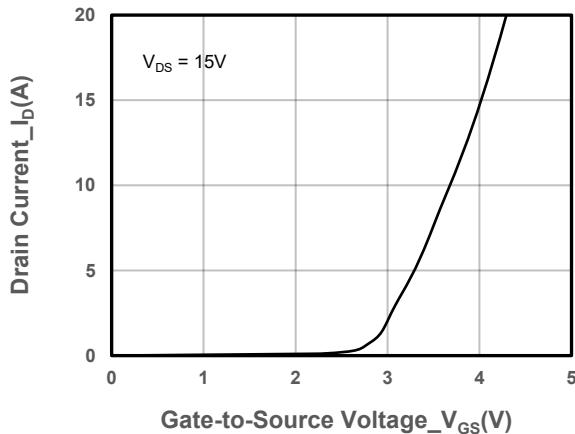
➤ P-Channel Electrical Characteristics ($T_A=25^\circ C$ unless otherwise noted)

| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------------------------|---------------|--|------|------|-----------|-----------|
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = -250\mu A$ | -40 | | | V |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = -250\mu A$ | -1.2 | | -2.2 | V |
| Drain-Source On-Resistance | $R_{DS(on)}$ | $V_{GS} = -10V, I_D = -15A$ | | 11.5 | 16 | $m\Omega$ |
| Drain-Source On-Resistance | $R_{DS(on)}$ | $V_{GS} = -4.5V, I_D = -10A$ | | 16.5 | 22 | $m\Omega$ |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = -40V, V_{GS} = 0V$ | | | -1 | μA |
| Gate-Source Leak Current | I_{GSS} | $V_{GS} = \pm 20V, V_{DS} = 0V$ | | | ± 100 | nA |
| Forward Voltage | V_{SD} | $V_{GS} = 0V, I_S = -15A$ | | | -1.28 | V |
| Gate Resistance | R_G | $V_{DS} = 0V, f = 1MHz$ | | 5.9 | | Ω |
| Input Capacitance | C_{iss} | $V_{DS} = -20V, V_{GS} = 0V,$ $f = 1MHz$ | | 2328 | | pF |
| Output Capacitance | C_{oss} | | | 179 | | |
| Reverse Transfer Capacitance | C_{rss} | | | 166 | | |
| Total Gate Charge | Q_G | $V_{GS} = -4.5V, V_{DS} = -15V,$ $I_D = -10A$ | | 30 | | nC |
| Gate to Source Charge | Q_{GS} | | | 8.5 | | |
| Gate to Drain Charge | Q_{GD} | | | 16 | | |
| Turn-on Delay Time | $T_{D(ON)}$ | $V_{GS} = -10V, V_{DS} = -15V,$ $I_D = -15A, R_{GEN} = 3.3\Omega$ | | 18 | | ns |
| Rise Time | T_r | | | 32 | | |
| Turn-off Delay Time | $T_{D(OFF)}$ | | | 66 | | |
| Fall Time | T_f | | | 40 | | |
| Diode Recovery Time | T_{rr} | $I_F = -15A, di/dt = 100A/us$ | | 57 | | ns |
| Diode Recovery Charge | Q_{rr} | $I_F = -15A, di/dt = 100A/us$ | | 32 | | nC |

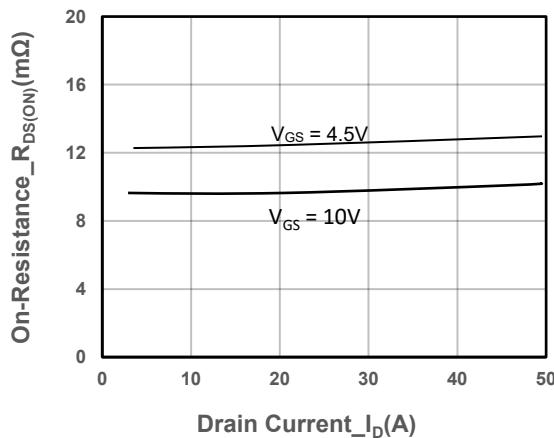
➤ N-Channel Typical Performance Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)



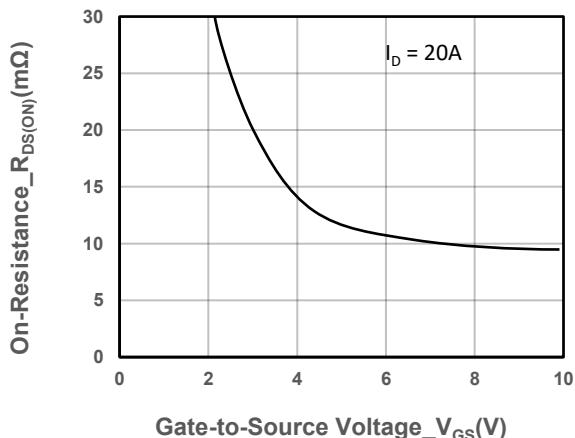
Output Characteristics



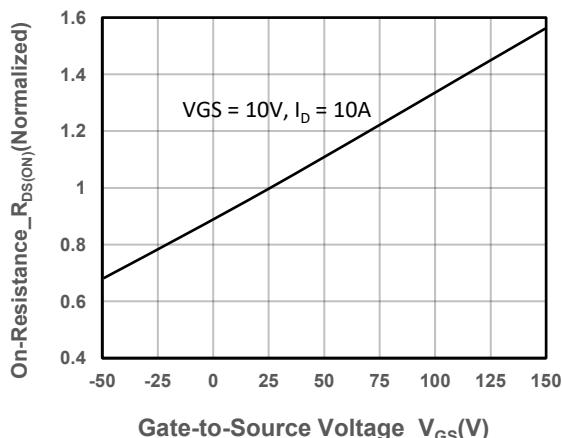
Transfer Characteristics



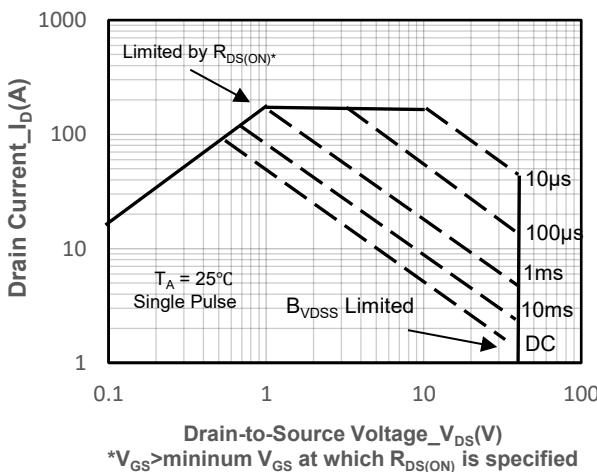
On-Resistance vs. Drain Current and Gate Voltage



On-Resistance vs. Gate-to-Source Voltage

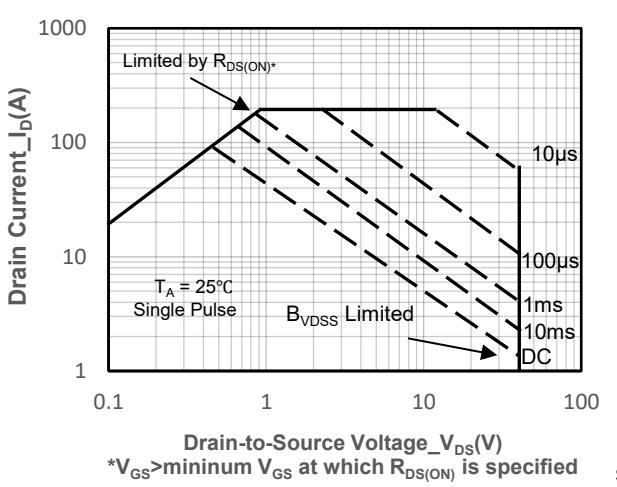
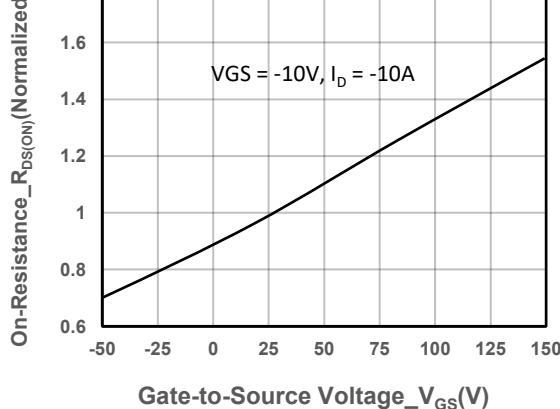
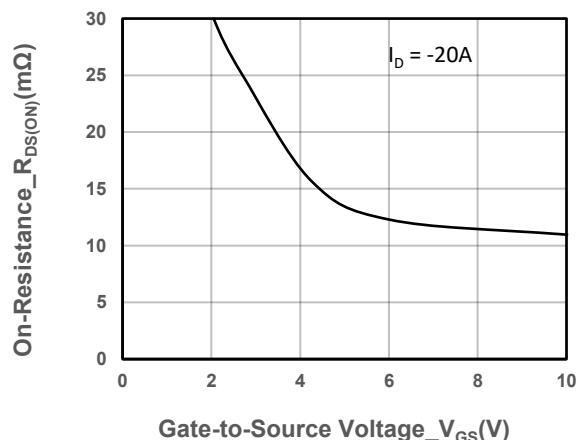
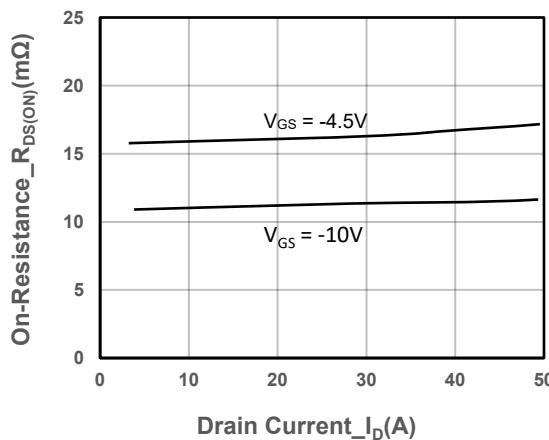
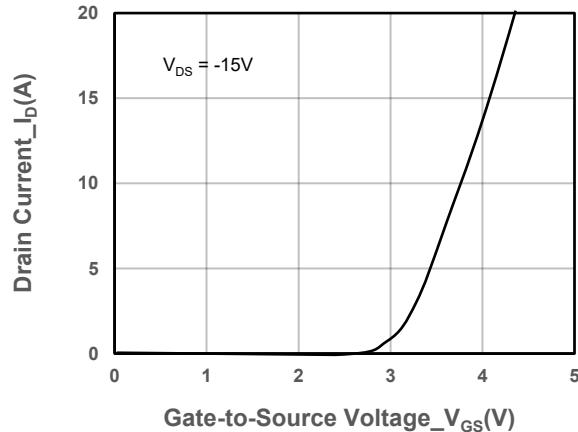
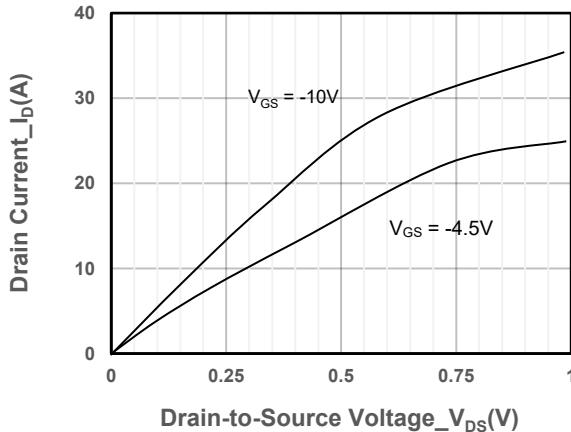


On-Resistance vs. Junction Temperature

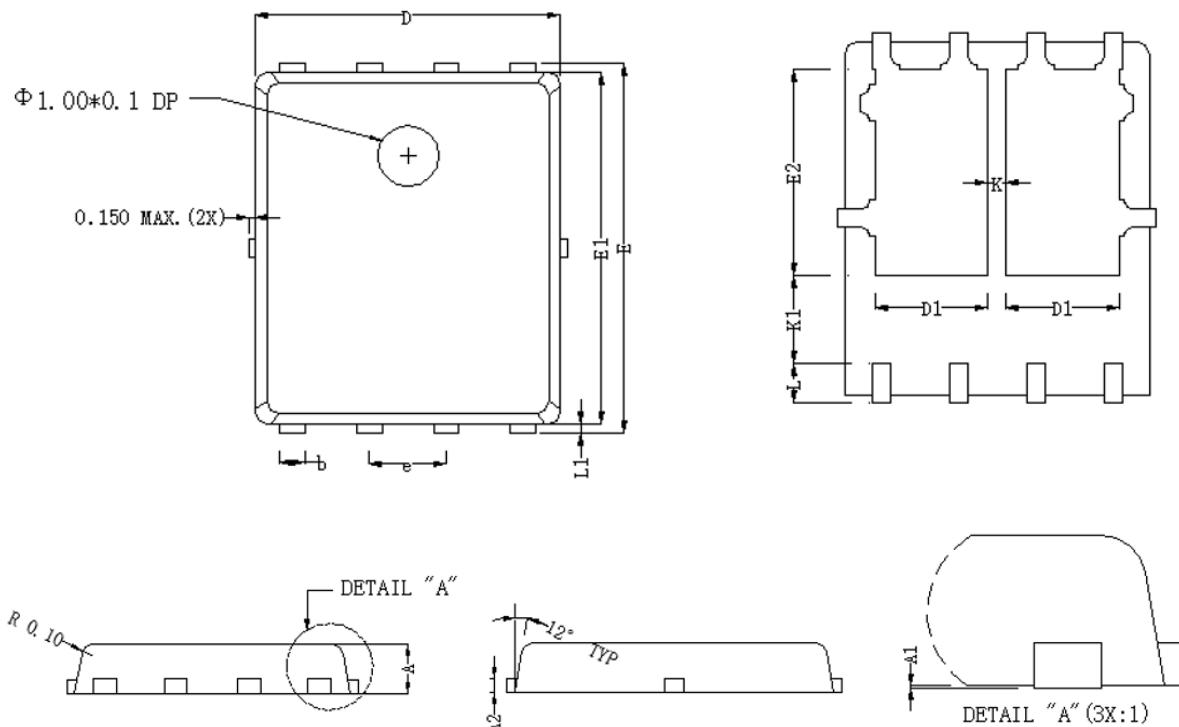


Safe Operating Area vs. Junction-to-Ambient

➤ P-Channel Typical Performance Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)



➤ Package Information



| Dimensions In Millimeterer | | | |
|----------------------------|-----------|------|------|
| Symbol | MIN | TYP | MAX |
| A | 0.90 | 1.00 | 1.10 |
| A1 | 0.00 | 0.03 | 0.05 |
| A2 | 0.254 REF | | |
| b | 0.25 | 0.30 | 0.35 |
| D | 4.80 | 4.90 | 5.00 |
| D1 | 1.60 | 1.70 | 1.80 |
| E | 5.90 | 6.00 | 6.10 |
| E1 | 5.65 | 5.75 | 5.85 |
| E2 | 3.38 | 3.48 | 3.58 |
| e | 1.27 BSC | | |
| K | 0.55 | 0.60 | 0.65 |
| K1 | 1.35 REF | | |
| L | 0.55 | 0.60 | 0.65 |
| L1 | 0.10 | 0.13 | 0.16 |

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